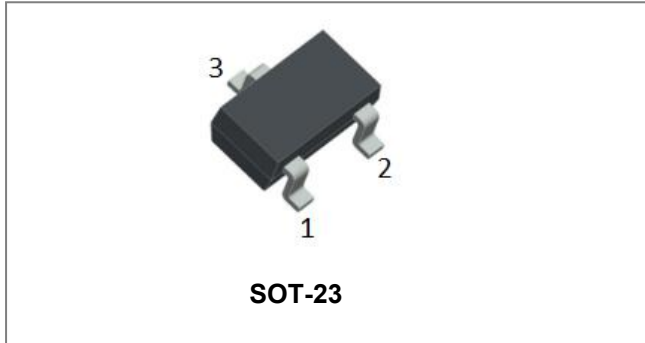


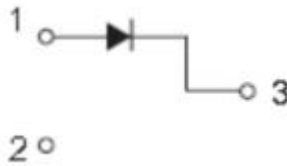
MMBZ5221B-MMBZ5259B ZENER DIODES



Features

- Planar Die Construction
- 410mW Power Dissipation
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Mechanical Characteristics

- Case: SOT-23, Molded Plastic
- Terminals: Plated leads Solderable per MIL-STD-750, Method 2026
- Mounting Position: Any
- Weight: 0.008g

Maximum Ratings@T_A=25°C unless otherwise specified

Parameter	Symbol	Value	Units
Power Dissipation (Note 1)	P _D	410	mW
Forward Voltage @ I _F = 10mA	V _F	1.0	V
Typical Thermal resistance junction to Ambient Air (Note 1)	R _{θJA}	357	°C/W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 150	°C

Notes: 1. Valid provided that device terminals are kept at ambient temperature.
 2. Tested with pulses, T_p ≤ 1.0ms.

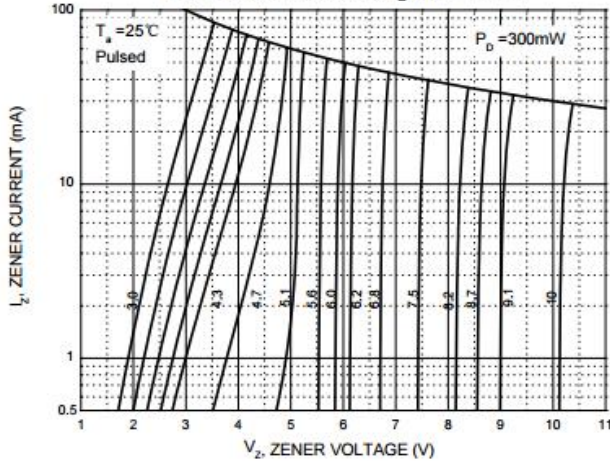
Electrical Characteristics @ $T_A=25^{\circ}\text{C}$ unless otherwise specified

Type Number	Marking Code	Zener Voltage Range (Note 1)			Test Current	Maximum Zener Impedance (Note 2)		Maximum Reverse Leakage Current (Note 1)	
		$V_z @ I_{zT}$				I_{zT}	$Z_{zT} @ I_{zT}$	$Z_{zK} @ I_{zK} = 0.25\text{mA}$	I_R
		Nom (V)	Min (V)	Max (V)	mA	Ω		μA	V
MMBZ5221B	KC1	2.4	2.28	2.52	20	30	1200	100	1.0
MMBZ5222B	KC2	2.5	2.38	2.63	20	30	1250	100	1.0
MMBZ5223B	KC3	2.7	2.57	2.84	20	30	1300	75	1.0
MMBZ5225B	KC5	3.0	2.85	3.15	20	30	1600	50	1.0
MMBZ5226B	KG1	3.3	3.14	3.47	20	28	1600	25	1.0
MMBZ5227B	KG2	3.6	3.42	3.78	20	24	1700	15	1.0
MMBZ5228B	KG3	3.9	3.71	4.10	20	23	1900	10	1.0
MMBZ5229B	KG4	4.3	4.09	4.52	20	22	2000	5.0	1.0
MMBZ5230B	KG5	4.7	4.47	4.94	20	19	1900	5.0	2.0
MMBZ5231B	KE1	5.1	4.85	5.36	20	17	1600	5.0	2.0
MMBZ5232B	KE2	5.6	5.32	5.88	20	11	1600	5.0	3.0
MMBZ5233B	KE3	6.0	5.70	6.30	20	7	1600	5.0	3.5
MMBZ5234B	KE4	6.2	5.89	6.51	20	7	1000	5.0	4.0
MMBZ5235B	KE5	6.8	6.46	7.14	20	5	750	3.0	5.0
MMBZ5236B	KF1	7.5	7.13	7.88	20	6	500	3.0	6.0
MMBZ5237B	KF2	8.2	7.79	8.61	20	8	500	3.0	6.5
MMBZ5238B	KF3	8.7	8.27	9.14	20	8	600	3.0	6.5
MMBZ5239B	KF4	9.1	8.65	9.56	20	10	600	3.0	7.0
MMBZ5240B	KF5	10	9.50	10.50	20	17	600	3.0	8.0
MMBZ5241B	KH1	11	10.45	11.55	20	22	600	2.0	8.4
MMBZ5242B	KH2	12	11.40	12.60	20	30	600	1.0	9.1
MMBZ5243B	KH3	13	12.35	13.65	9.5	13	600	0.5	9.9
MMBZ5244B	KH4	14	13.30	14.70	9.0	15	600	0.1	10
MMBZ5245B	KH5	15	14.25	15.75	8.5	16	600	0.1	11
MMBZ5246B	KJ1	16	15.20	16.80	7.8	17	600	0.1	12
MMBZ5247B	KJ2	17	16.15	17.85	7.4	19	600	0.1	13
MMBZ5248B	KJ3	18	17.10	18.90	7.0	21	600	0.1	14
MMBZ5249B	KJ4	19	18.05	19.95	6.6	23	600	0.1	14
MMBZ5250B	KJ5	20	19.00	21.00	6.2	25	600	0.1	15
MMBZ5251B	KK1	22	20.90	23.10	5.6	29	600	0.1	17
MMBZ5252B	KK2	24	22.80	25.20	5.2	33	600	0.1	18
MMBZ5253B	KK3	25	23.75	26.25	5.0	35	600	0.1	19
MMBZ5254B	KK4	27	25.65	28.35	5.0	41	600	0.1	21
MMBZ5255B	KK5	28	26.80	29.40	4.5	44	600	0.1	21
MMBZ5256B	KM1	30	28.50	31.50	4.2	49	600	0.1	23
MMBZ5257B	KM2	33	31.35	34.65	3.8	58	700	0.1	25
MMBZ5258B	KM3	36	34.20	37.80	3.4	70	700	0.1	27
MMBZ5259B	KM4	39	37.05	40.95	3.2	80	800	0.1	30

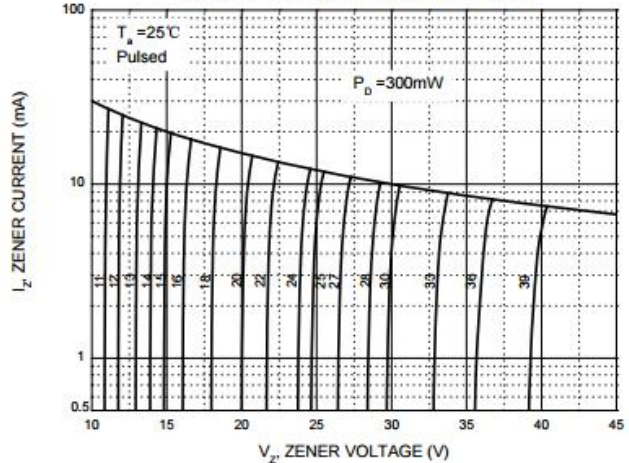
Notes: 1. Short duration test pulse used to minimize self-heating effect.
 2. $f = 1\text{kHz}$.

Ratings and Characteristics Curves

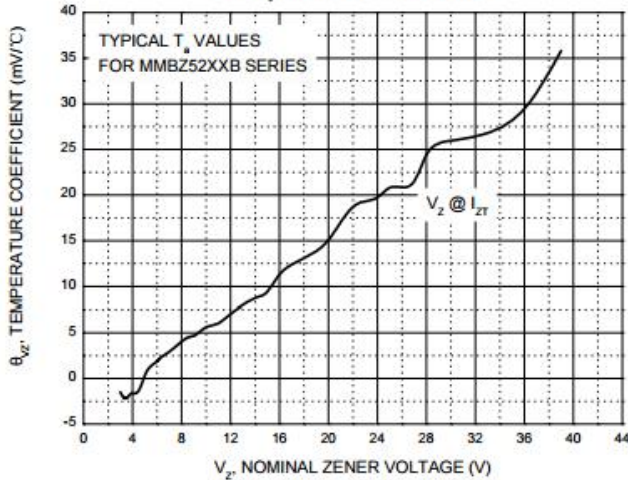
Zener Characteristics (V_z Up to 10 V)



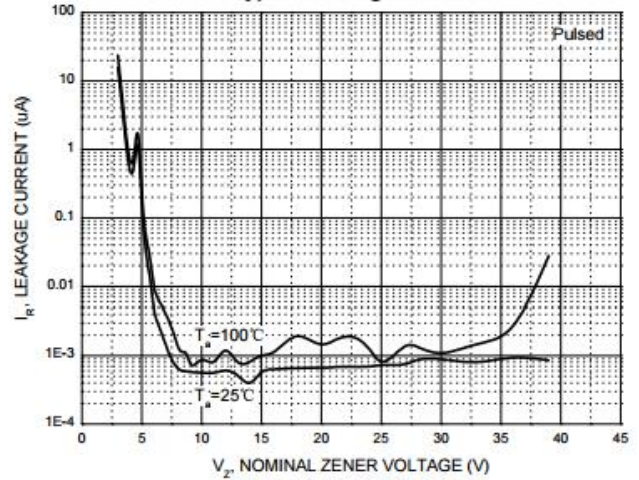
Zener Characteristics (11 V to 39 V)



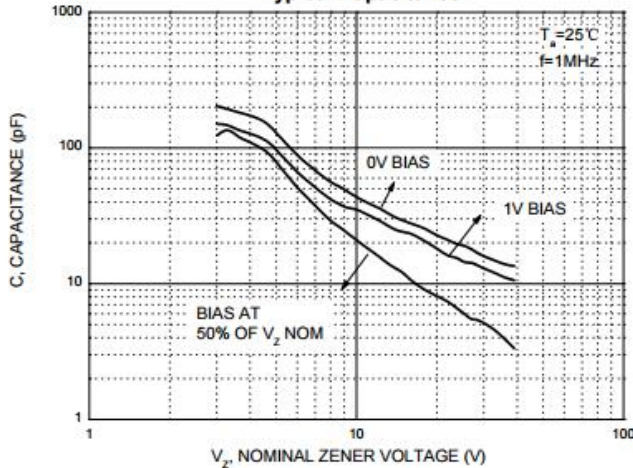
Temperature Coefficients



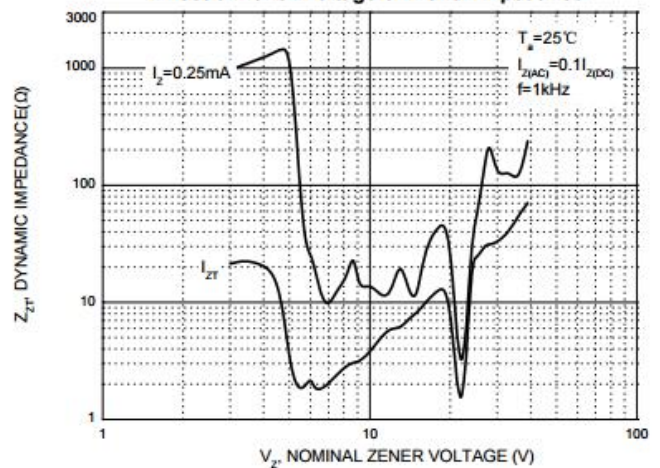
Typical Leakage Current



Typical Capacitance



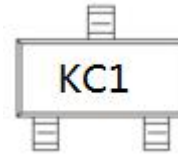
Effect of Zener Voltage on Zener Impedance



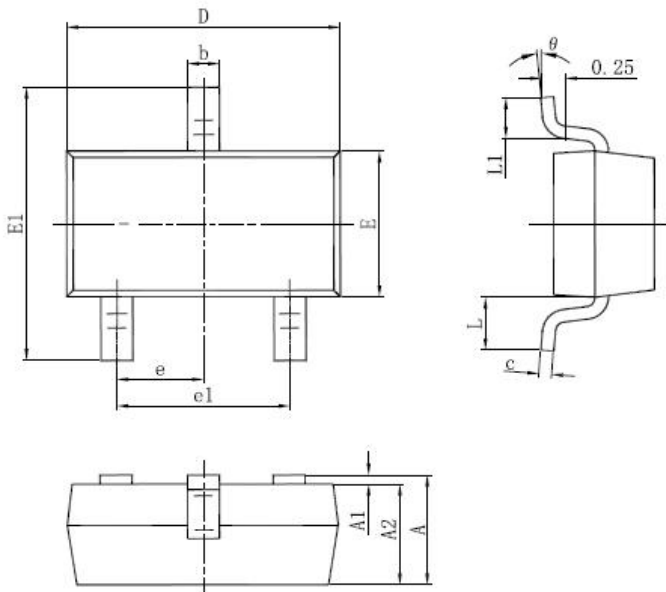
Ordering Information

Device	Package	Shipping
MMBZ5221B- MMBZ5259B	SOT-23 (Pb-Free)	3000pcs / reel

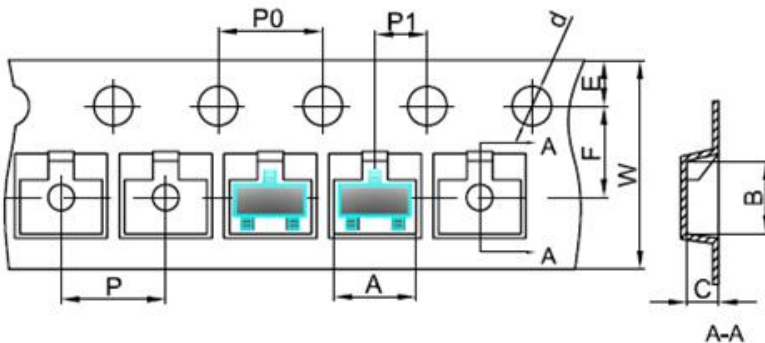
For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram


KC1 = Marking Code

Mechanical Dimensions SOT-23


SYMBOL	Millimeters		Inches	
	MIN.	MAX.	MIN.	MAX.
A	0.890	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.076	0.170	0.003	0.007
D	2.650	3.050	0.104	0.120
E	1.190	1.400	0.047	0.055
E1	2.100	2.550	0.083	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.780	2.050	0.070	0.081
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Carrier Tape Specification SOT-23


SYMBOL	Millimeters	
	Min.	Max.
A	3.05	3.25
B	2.67	2.87
C	1.12	1.32
d	1.40	1.60
E	1.65	1.85
F	3.40	3.60
P	3.90	4.10
P0	3.90	4.10
P1	1.90	2.10
W	7.90	8.30

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